

# TPCF8101

Notebook PC Applications

Portable Equipment Applications

- Low drain-source ON resistance:  $R_{DS(ON)} = 22 \text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 14 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = -10 \text{ }\mu\text{A}$  (max) ( $V_{DS} = -12 \text{ V}$ )
- Enhancement-model:  $V_{th} = -0.5 \text{ to } -1.2 \text{ V}$   
( $V_{DS} = -10 \text{ V}$ ,  $I_D = -200 \text{ }\mu\text{A}$ )

## Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	-12	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	-12	V
Gate-source voltage		$V_{GSS}$	$\pm 8$	V
Drain current	DC (Note 1)	$I_D$	-6	A
	Pulsed (Note 1)	$I_{DP}$	-24	
Drain power dissipation (t = 5 s) (Note 2a)		$P_D$	2.5	W
Drain power dissipation (t = 5 s) (Note 2b)		$P_D$	0.7	W
Single pulse avalanche energy (Note 3)		$E_{AS}$	6.3	mJ
Avalanche current		$I_{AR}$	-3	A
Repetitive avalanche energy (Note 4)		$E_{AR}$	0.25	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-55~150	$^\circ\text{C}$

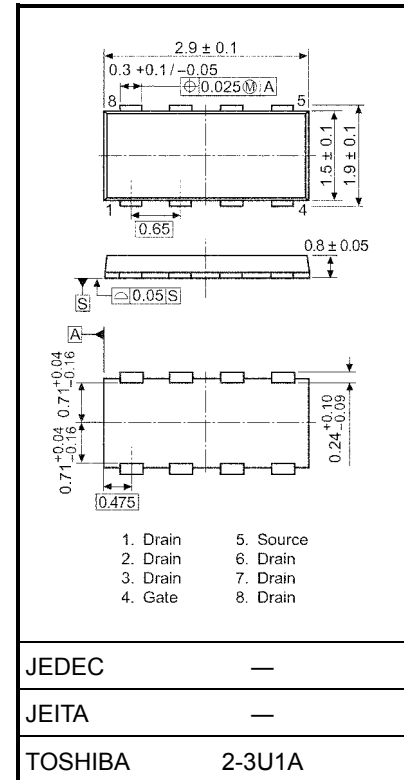
## Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	$R_{th(ch-a)}$	50.0	$^\circ\text{C/W}$
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	$R_{th(ch-a)}$	178.6	$^\circ\text{C/W}$

Note: For (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5), please refer to the next page.

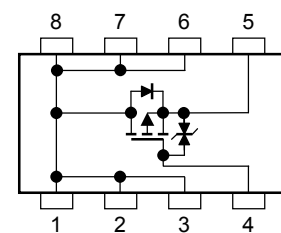
This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

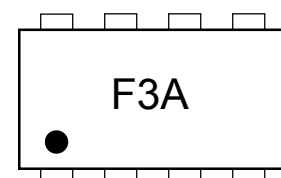


Weight: 0.011 g (typ.)

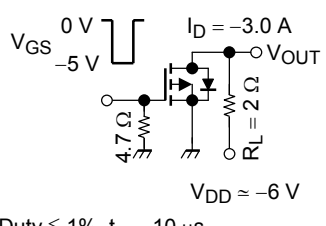
## Circuit Configuration



## Marking (Note 5)



## Electrical Characteristics (Ta = 25°C)

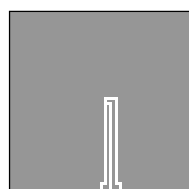
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-off current		$I_{DSS}$	$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	-10	$\mu\text{A}$
Drain-source breakdown voltage	$V_{(BR)DSS}$		$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-12	—	—	V
	$V_{(BR)DSX}$		$I_D = -10 \text{ mA}, V_{GS} = 8 \text{ V}$	-4	—	—	
Gate threshold voltage		$V_{th}$	$V_{DS} = -10 \text{ V}, I_D = -200 \mu\text{A}$	-0.5	—	-1.2	V
Drain-source ON resistance	$R_{DS(ON)}$		$V_{GS} = -1.8 \text{ V}, I_D = -1.5 \text{ A}$	—	60	85	m $\Omega$
	$R_{DS(ON)}$		$V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$	—	32	40	
	$R_{DS(ON)}$		$V_{GS} = -4.5 \text{ V}, I_D = -3.0 \text{ A}$	—	22	28	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = -10 \text{ V}, I_D = -3.0 \text{ A}$	7	14	—	S
Input capacitance		$C_{iss}$	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	1600	—	pF
Reverse transfer capacitance		$C_{rss}$		—	260	—	
Output capacitance		$C_{oss}$		—	335	—	
Switching time	Rise time	$t_r$	 <p><math>V_{DD} \approx -6 \text{ V}</math> Duty <math>\leq 1\%</math>, <math>t_w = 10 \mu\text{s}</math></p>	—	7	—	ns
	Turn-on time	$t_{on}$		—	13	—	
	Fall time	$t_f$		—	21	—	
	Turn-off time	$t_{off}$		—	68	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx -10 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -6.0 \text{ A}$	—	18.0	—	nC
Gate-source charge		$Q_{gs}$		—	14.5	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	3.5	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	$I_{DRP}$	—	—	—	-24	A
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = -6.0 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	1.2	V

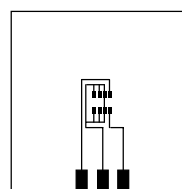
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



(a)

FR-4  
25.4 × 25.4 × 0.8  
Unit: (mm)



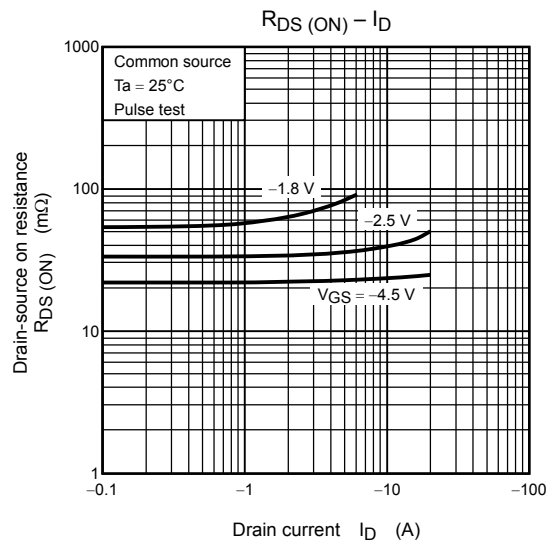
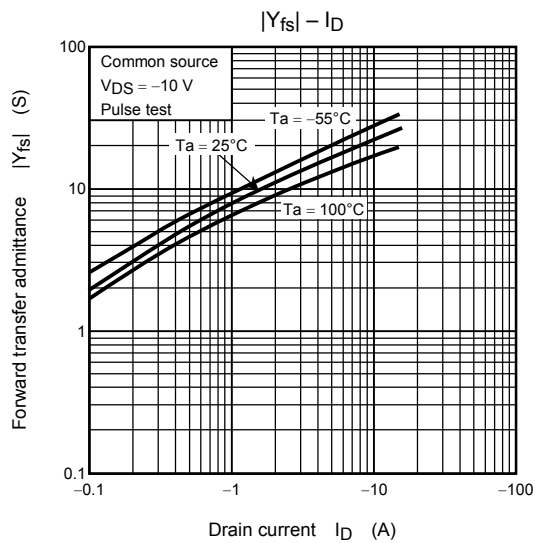
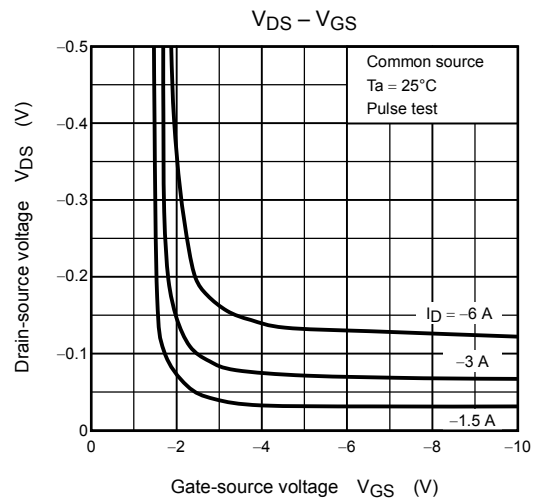
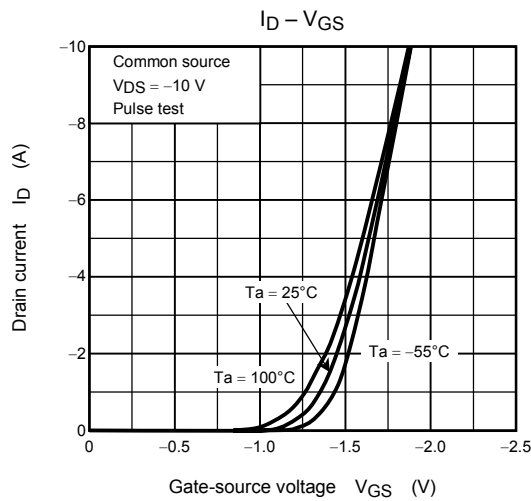
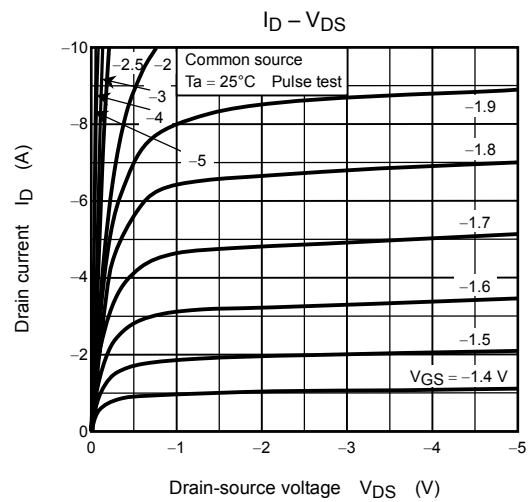
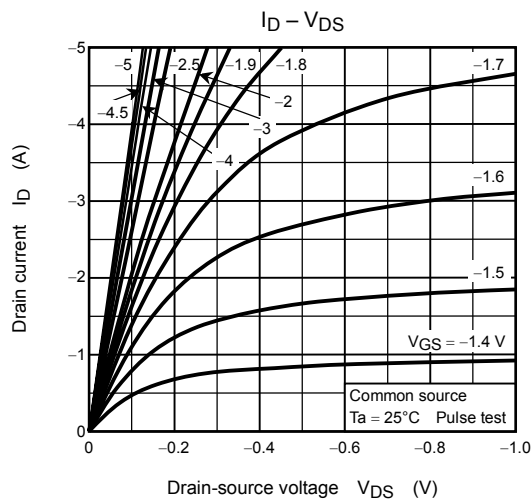
(b)

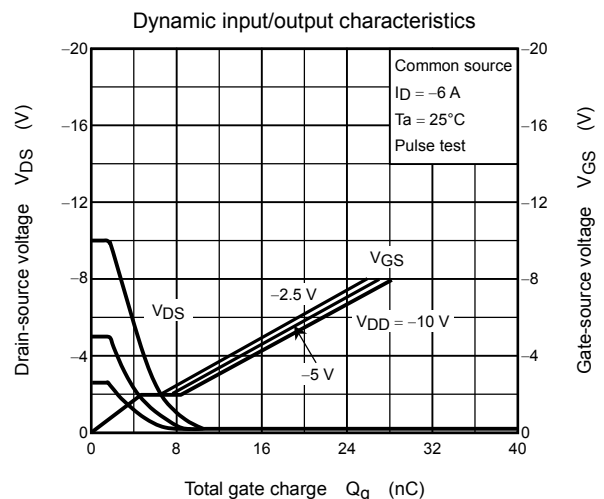
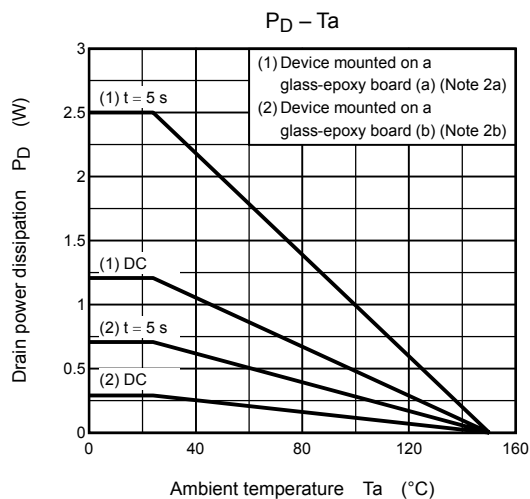
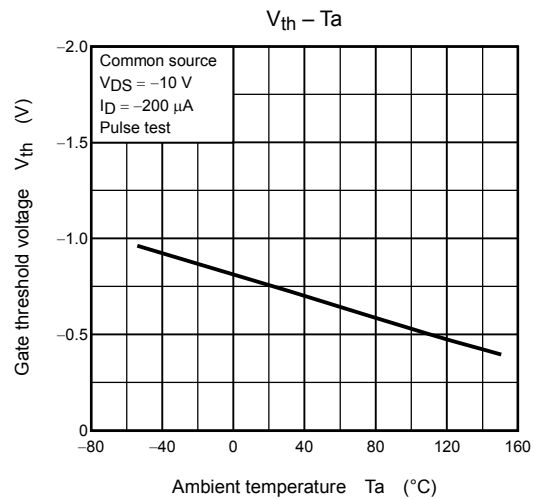
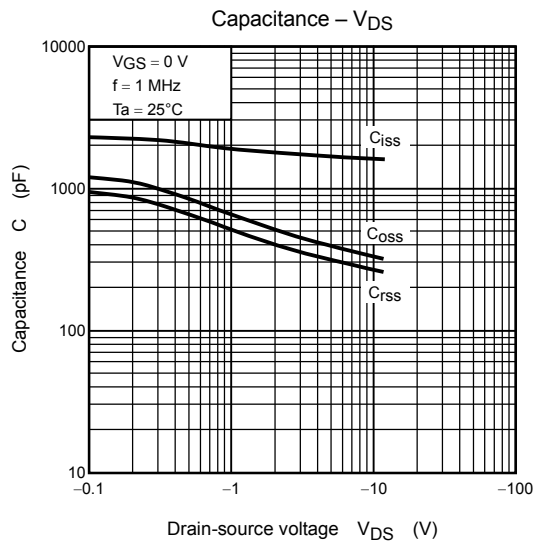
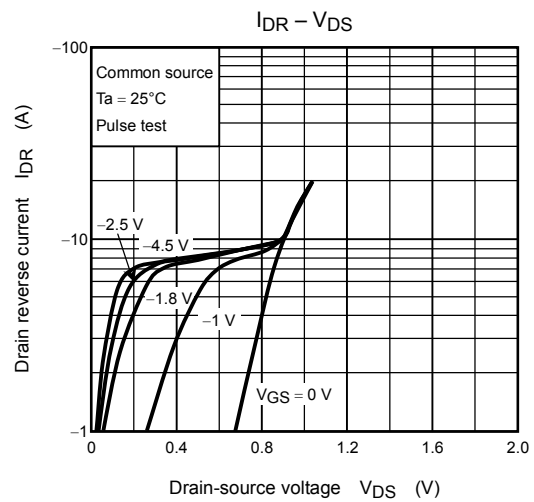
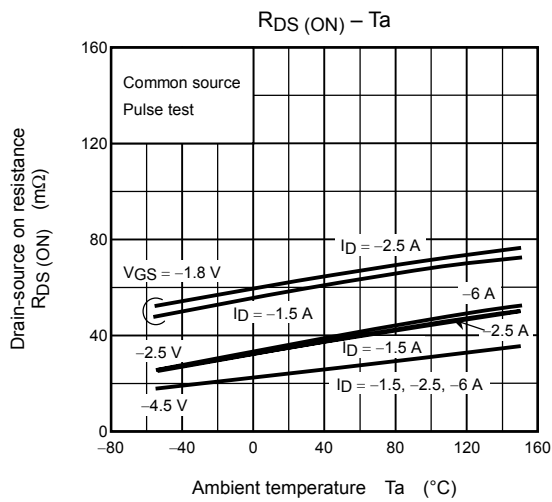
FR-4  
25.4 × 25.4 × 0.8  
Unit: (mm)

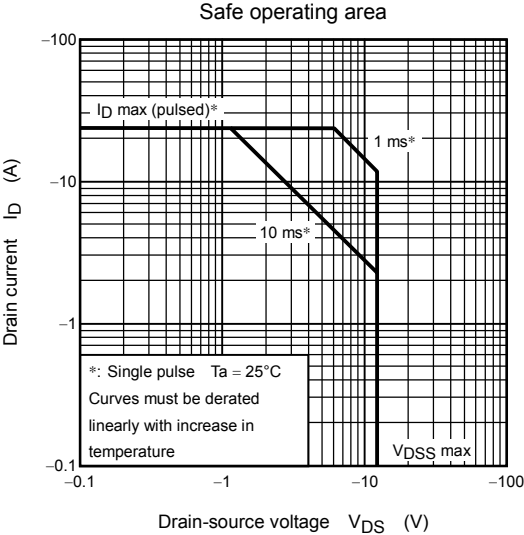
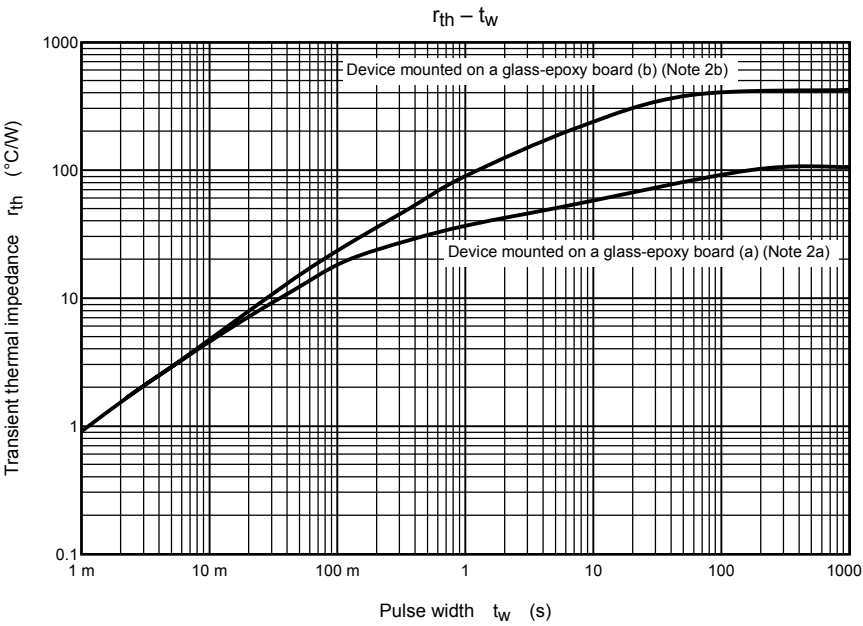
Note 3:  $V_{DD} = -10 \text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 0.5 \text{ mH}$ ,  $R_G = 25 \Omega$ ,  $I_{AR} = -3.0 \text{ A}$

Note 4: Repetitive rating: pulse width limited by Max. Channel temperature.

Note 5: Black round marking "●" locates on the left lower side of parts number "F3A" indicates terminal No.1.







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